

Application Data Sheet**Application Information**

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| Application number:: | Not Yet Assigned |
| Application Type:: | Regular |
| Subject Matter:: | Utility |
| Suggested Group Art Unit:: | N/A |
| CD-ROM or CD-R?:: | None |
| Sequence submission?:: | None |
| Computer Readable Form (CRF)?:: | No |
| Title:: | METHOD FOR REMOVING A RESIST MASK WITH HIGH SELECTIVITY TO A CARBON HARD MASK USED FOR SEMICONDUCTOR STRUCTURING |
| Attorney Docket Number:: | 543822003300 |
| Request for Early Publication?:: | No |
| Request for Non-Publication?:: | No |
| Small Entity?:: | No |
| Petition included?:: | No |
| Secrecy Order in Parent Appl.?:: | No |

Applicant Information

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|---|--------------------------|
| Applicant Authority Type:: | Inventor |
| Primary Citizenship Country:: | India |
| Status:: | Full Capacity |
| Given Name:: | Srivatsa |
| Family Name:: | KUNDALGURKI |
| City of Residence:: | Dresden |
| Country of Residence:: | Germany |
| Street of mailing address:: | Theodor-Fontane-Straße 5 |
| City of mailing address:: | Dresden |
| Country of mailing address:: | Germany |
| Postal or Zip Code of mailing address:: | D-01109 |

Correspondenc Information

Correspondence Customer Number:: 25227

Representative Information

Representative Customer Number:: 25227

Assignee Information

Assignee name:: Infineon Technologies AG

Street of mailing address:: St.-Martin Strasse 53

City of mailing address:: München

Country of mailing address:: Germany

Postal or Zip Code of mailing address:: 81669